

Bonding pastes, Putties, anti-bubble/radius compounds, cavity fillers.

Reference	Application			Viscosity / poises	Thix. Index	Density (± 0,05)	Gel time / min (on 130gr mass, at 20°C, 2% MEKP 50)	Exothermic peak / °C (± 10°C)	Comments
	Bonding paste	Anti-bubble	Cavity filling						
FSP-HV 1528	•	•	•	2300-2800	≥ 5	0,6	15-30	150	Low density product, high rigidity, no water uptake. Application in high thickness. Polyvalent product.
FSP-HV 1534	•	•	•	3000-3500	≥ 8	0,8	15-30		Core material bonding (PU & PVC foams, balsa, etc). Medium reactivity. Smooth to apply. Polyvalent product.
FSP-HV 1535	•	•	•	3000-3500	≥ 8	0,8	40-55		Core material bonding (PU & PVC foams, balsa, etc). Low reactivity. Smooth to apply. Polyvalent product.
FSP-HV 1590	•	•		3300-3800	≥ 8	0,8	60-80		Anti-bubbles and bonding paste, very low reactivity. Smooth to apply. Ideal for big parts and before injection.
FSP-HV 1537	•			5200-6000	≥ 7	1,3	15-30		Bonding paste, for balsa, PU & PVC foams, etc. Smooth to apply. Medium reactivity. Low shrink. Fast version available.
FSP-HV 1537 S	•			5200-6000	≥ 7	1,3	6-12		Bonding-paste, similar to 1537, with higher reactivity.
FSP-HV 1538 FIBRE	•		•	15000-20000	≥ 5,5	1,33	25-40		Fibre-reinforced bonding paste. Good flexibility and low shrink. Smooth to apply. High thixotropy for thickness application. Fast version available.
FSP-HV 1538 S FIBRE	•		•	15000-20000	≥ 5,5	1,33	6-12		Fibre-reinforced bonding paste, similar to 1538 with higher reactivity.
FSP-VE 9000	•			4000-5000	≥ 6,5	1,1	40-65	120	100% vinlyester non-filled bonding paste, for high performance structural bondings. Hand or machine application.

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